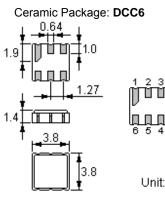


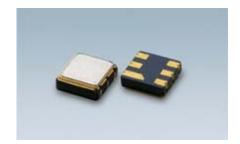
Features

- Low-loss RF filter for CDMA450
- High Rejection
- Ceramic Package for Surface Mounted Technology (SMT)
- Lead-free production and **RoHS** compliance

Package Dimensions



Unit: mm



Pin Configuration

2	Input
5	Output
1, 3, 4, 6	Case Ground
1, 3, 4, 6	To Be Grounded

Marking

	٦				Т	op View	, Laser N	Marking				
NDF: 4116	*		"NI	D ":	Manufac	turer's r	nark	" F ":	SAW fil	lter		
4116			"41 <i>"</i>	16":	Part num	""	Termina	al 1				
			" *	.":	Lot num	ber (The	code sł	nown be	low vari	ies in a 4	4-year c	ycle)
		•	•		-	•	-	•	•	4.0		4.0

Code	1	2	3	4	5	6	7	8	9	10	11	12
2005	А	В	С	D	Е	F	G	Н	J	K	L	М
2006	Ν	Р	Q	R	S	Т	U	V	W	Х	Y	Z
2007	а	b	С	d	е	f	g	h	i	j	k	m
2008	n	р	q	r	S	t	u	v	w	х	у	z

Maximum Ratings

Rating		Value	Unit
Operating Temperature Range	T _A	-40 ~ +85	°C
Storage Temperature Range	T_{stg}	-40 ~ +85	°C
DC Voltage (between any Terminals)	V _{DC}	0	V
RF Power (in <i>BW</i>)	Р	30 max.	dBm
ESD Voltage (HB)	V_{ESD}	250	V

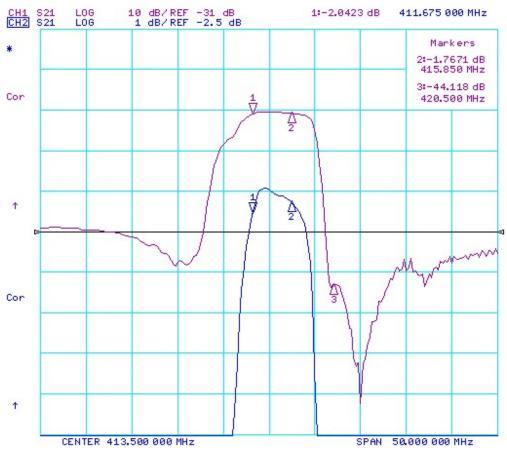


Electrical Characteristics

Item		Minimum	Typical	Maximum	Unit
Frequency	f _C	411.675		415.850	MHz
Maximum Insertion Loss in 411.675 MHz-415.850 MHz	IL	-	2.1	2.4	dB
Absolute Attenuation	α				
0.300 310.000 MHz		27	32	-	dB
310.000 402.000 MHz		25	30	-	dB
420.500 425.500 MHz		40	45	-	dB
425.500 870.000 MHz		20	25	-	dB
870.000 1500.00 MHz		25	30		dB
1500.00 2000.00 MHz		17	20		dB
Amplitude Variation in 411.675 MHz-415.850 MHz	Δα	-	0.8	1.2	dB
Input VSWR in 411.675 MHz-415.850 MHz		-	1.5:1	2.0:1	
Output VSWR in 411.675 MHz-415.850 MHz		-	1.5:1	2.0:1	
Source / Load Impedance			50	•	Ω

🕲 RoHS Compliant 🕕 🛈 Electrostatic Sensitive Device

Typical Frequency Response





Stability Characteristics

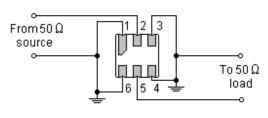
	Test item	Condition of te	est
1	Mechanical shock	(a) Drops: 3 times on concrete floor (b) Height: 1.0 m	
2	Vibration resistance	(a) Frequency of vibration: 10~55Hz (c) Directions: X,Y and Z	(b) Amplitude: 1.5 mm (d) Duration: 2 hours
3	Moisture resistance	(a) Condition: 40°C, 90~95% R.H. (c) Wait 4 hours before measurement	(b) Duration: 96 hours
4	Climatic sequence		for 24 hours, 90~95% R.H. for 24 hours, 90~95% R.H.
5	High temperature exposure	(a) Temperature: 70°C (c) Wait 4 hours before measurement	(b) Duration: 250 hours
6	Thermal impact	(a) +70°C for 30 minutes \Rightarrow -25°C for 30 m (b) Wait 4 hours before measurement	inutes repeated 3 times

Requirements: The SAW filer shall remain within the electrical specifications after tests.

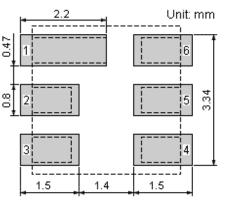
Remarks

- SAW devices should not be used in any type of fluid such as water, oil, organic solvent, etc.
- Be certain not to apply voltage exceeding the rated voltage of components.
- Do not operate outside the recommended operating temperature range of components.
- Sudden change of temperature shall be avoided, deterioration of the characteristics can occur.
- Be careful of soldering temperature and duration of components when soldering.
- Do not place soldering iron on the body of components.
- Be careful not to subject the terminals or leads of components to excessive force.
- SAW devices are electrostatic sensitive. Please avoid static voltage during operation and storage.
- Ultrasonic cleaning shall be avoided. Ultrasonic vibration may cause destruction of components.

Test Circuit



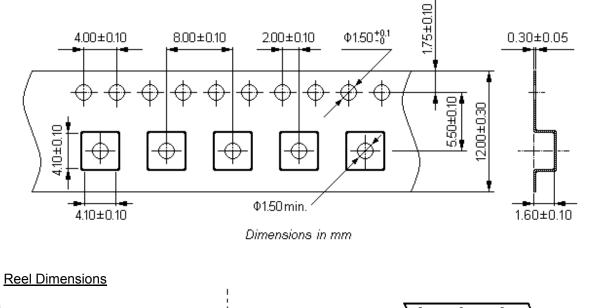
Recommended Land Pattern

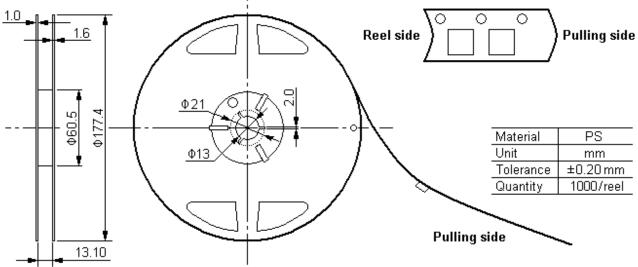




Packing Information

Carrier Tape



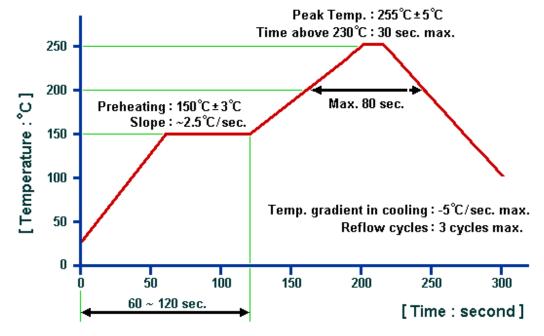


Outer Packing

Туре	Quantity	Dimension	Description	Weight
Carton Box I	5000	190×190×95	anti-static plastic bag & carton box 1 reel / bag	0.85
Carton Box II	10000	190×190×190	5 bags / box (5000 pcs) 10 bags / box (10000 pcs)	1.70
		Unit: mm		Unit: kg



Recommended Soldering Profile



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- 1. The specifications of this device are subject to change or obsolescence without notice.
- 2. Typically, equipment utilizing this device requires emissions testing and government approval, which is the responsibility of the equipment manufacturer.
- Our liability is only assumed for the Surface Acoustic Wave (SAW) component(s) per se, not for applications, processes and circuits implemented within components or assemblies.
- 4. For questions on technology, prices and delivery, please contact our sales offices or e-mail winnsky@winnsky.com

WINNSKY INTERNATIONAL (H.K.) LIMITED